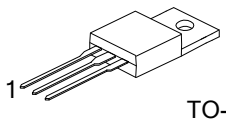
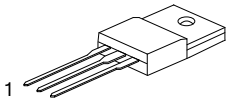
8 Amps, 500 Volts
N-CHANNEL POWER MOSFET



TO-220



TO-220F1

■ DESCRIPTION

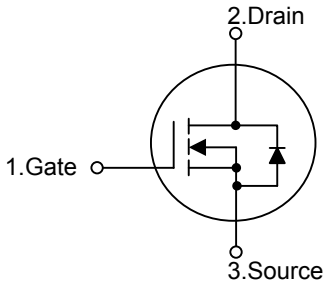
The UTC **8N50** is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **8N50** is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

■ FEATURES

* 8A, 500V, $R_{DS(ON)}$=0.85Ω @ V_{GS}=10V
* High Switching Speed
* 100% Avalanche Tested

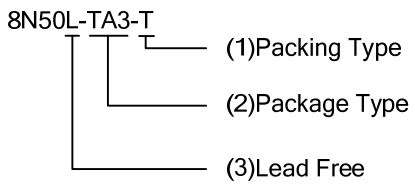
■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
8N50L-TA3-T	8N50G-TA3-T	TO-220	G	D	S	Tube
8N50L-TF1-T	8N50G-TF1-T	TO-220F1	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source



(1) T: Tube

(2) TA3: TO-220 ,TF1: TO-220F1

(3) G: Halogen Free, L: Lead Free

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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V_{DSS}	500	V
Gate-Source Voltage			V_{GSS}	±30	V
Drain Current	Continuous (T_C=25°C)		I_D	8(Note 2)	A
	Pulsed (Note 3)		I_{DM}	32(Note 2)	A
Avalanche Current (Note 3)			I_{AR}	8	A
Avalanche Energy	Single Pulsed (Note 4)		E_{AS}	320	mJ
	Repetitive (Note 5)		E_{AR}	12.5	mJ
Power Dissipation	T_C=25°C	TO-220	P_D	125	W
		TO-220F1		42	
	Derate above 25°C	TO-220		1	W/°C
		TO-220F1		0.33	
Junction Temperature			T_J	+150	°C
Storage Temperature			T_{STG}	-55~+150	°C

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Drain current limited by maximum junction temperature
3. Repetitive Rating: Pulse width limited by maximum junction temperature
4. L = 10mH, I_{AS} = 8A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
5. I_{SD} ≤ 8A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220	θ_{JA}	62.5	°C/W
	TO-220F1		62.5	
Junction to Case	TO-220	θ_{JC}	1	°C/W
	TO-220F1		3	

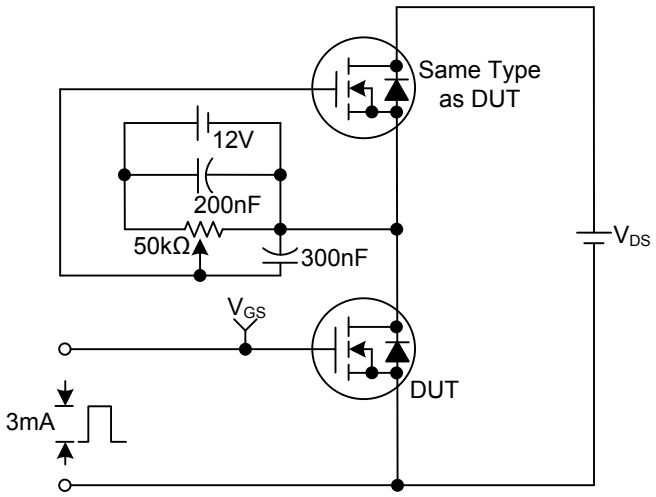
■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=250μA, V_{GS}=0V	500			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=500V, V_{GS}=0V			25	μA
Gate- Source Leakage Current	Forward	I_{GSS}	V_{GS}=+30V, V_{DS}=0V			+100	nA
	Reverse		V_{GS}=-30V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=4.5A		0.85		Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=25V, f=1.0MHz		850	1130	pF
Output Capacitance		C_{OSS}			115	155	pF
Reverse Transfer Capacitance		C_{RSS}			9	13.5	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V_{GS}=10V, V_{DS}=400V, I_D=8A (Note 6, 7)		18	24	nC
Gate to Source Charge		Q_{GS}			5		nC
Gate to Drain Charge		Q_{GD}			7.5		nC
Turn-ON Delay Time		$t_{D(ON)}$	V_{DD}=250V, I_D=8A, R_G=25Ω (Note 6, 7)		15	40	ns
Rise Time		t_R			38	86	ns
Turn-OFF Delay Time		$t_{D(OFF)}$			46	102	ns
Fall-Time		t_F			33	76	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				8	A
Maximum Body-Diode Pulsed Current		I_{SM}				32	A
Drain-Source Diode Forward Voltage		V_{SD}	I_S=8A, V_{GS}=0V			1.6	V
Body Diode Reverse Recovery Time		t_{RR}	I_S=8A, V_{GS}=0V, dI_F/dt=100A/μs (Note 6)		44		ns
Body Diode Reverse Recovery Charge		Q_{RR}			45		μC

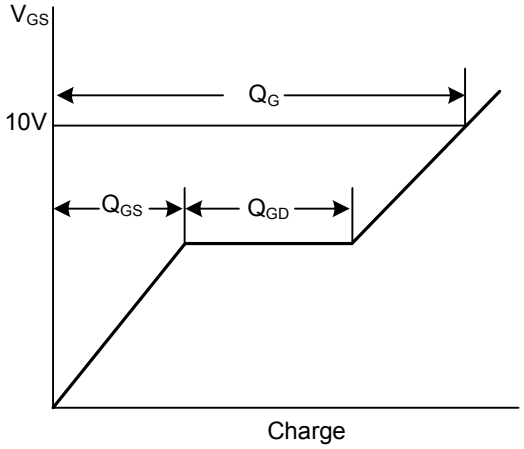
Notes: 6. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%
7. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

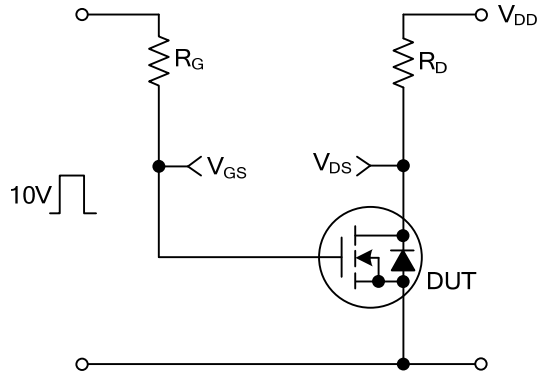
Gate Charge Test Circuit



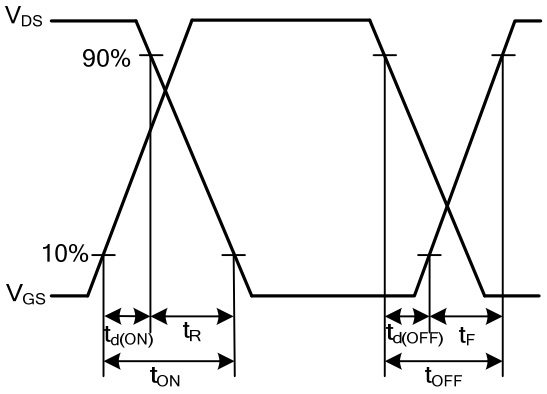
Gate Charge Waveforms



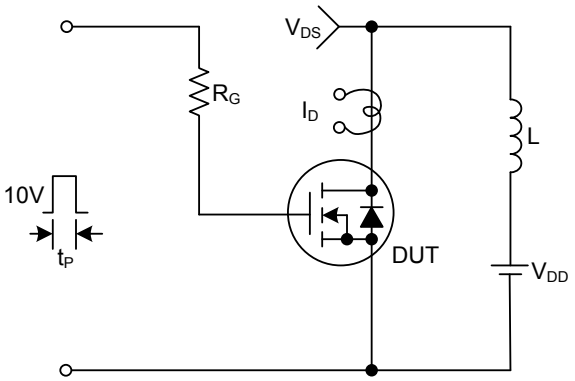
Resistive Switching Test Circuit



Resistive Switching Waveforms

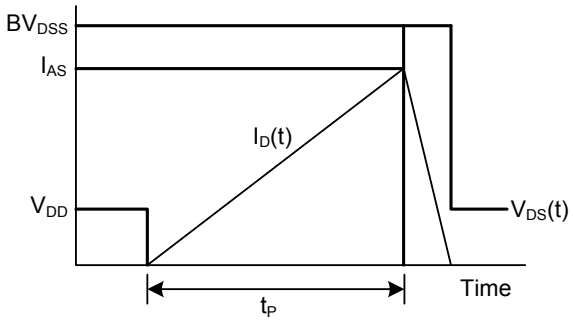


Unclamped Inductive Switching Test Circuit

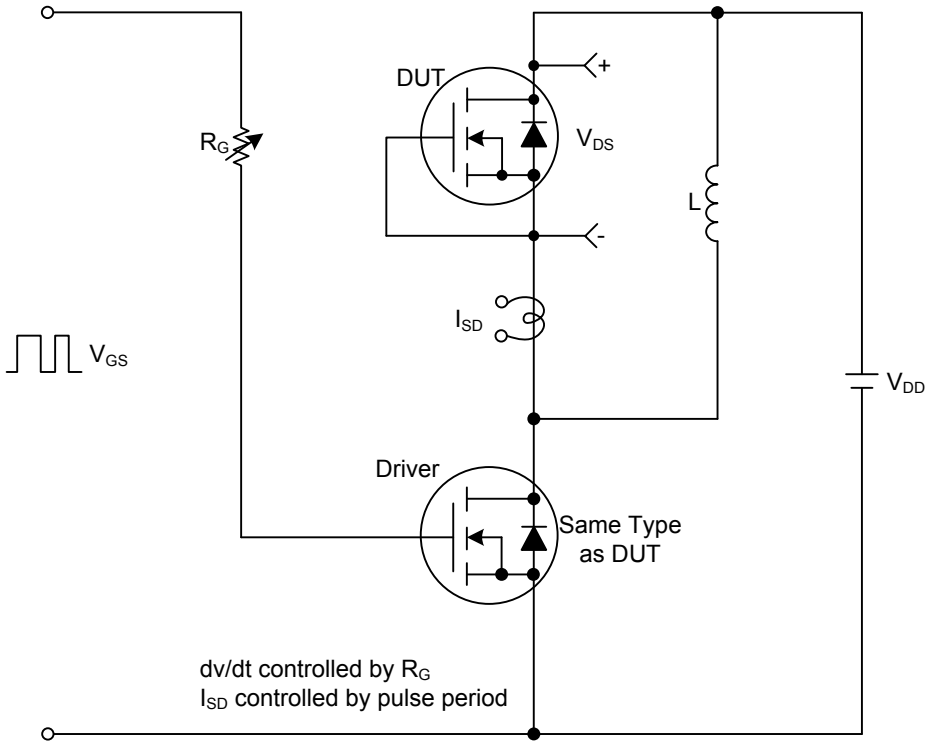


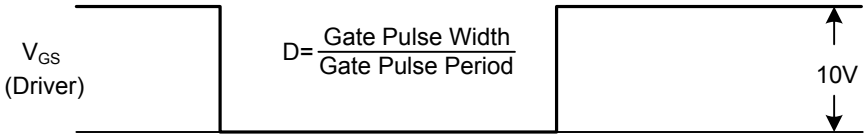
Unclamped Inductive Switching Waveforms

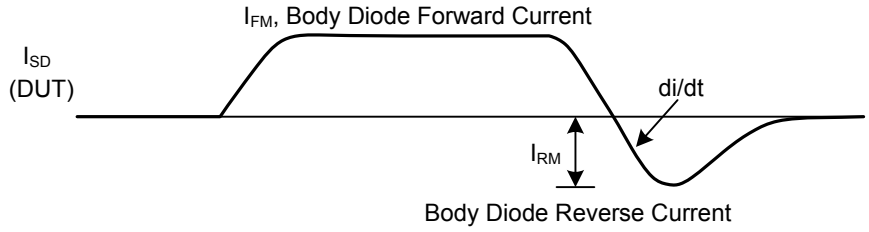
$$E_{AS}=\frac{1}{2}LI_{AS}^{2}\frac{BV_{DSS}}{BV_{DSS}-V_{DD}}$$

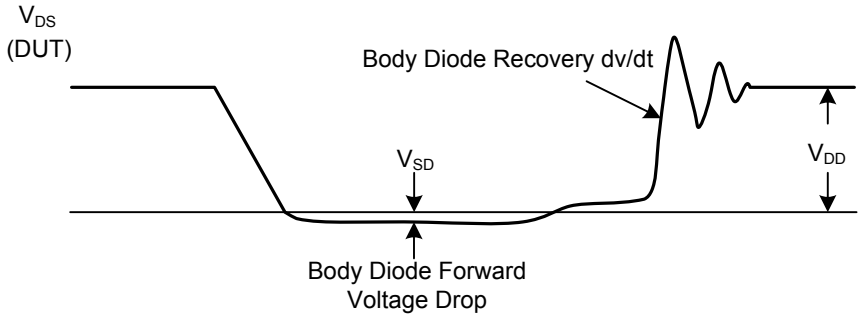


Peak Diode Recovery dv/dt Test Circuit & Waveforms









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